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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

E·XF

2000	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	17
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1509t-i-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

7.0 INTERRUPTS

The interrupt feature allows certain events to preempt normal program flow. Firmware is used to determine the source of the interrupt and act accordingly. Some interrupts can be configured to wake the MCU from Sleep mode.

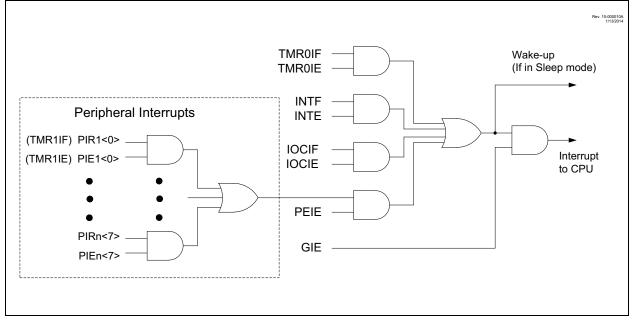
This chapter contains the following information for Interrupts:

- Operation
- Interrupt Latency
- Interrupts During Sleep
- INT Pin
- Automatic Context Saving

Many peripherals produce interrupts. Refer to the corresponding chapters for details.

A block diagram of the interrupt logic is shown in Figure 7-1.





R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	
TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	—	TMR2IE	TMR1IE	
bit 7							bit (
Legend:								
R = Readable	hit	W = Writable	hit	II – Unimpler	nented bit, read	1 26 (0)		
u = Bit is unch		x = Bit is unknown		•		R/Value at all o	thar Resots	
'1' = Bit is set	ungeu	'0' = Bit is cle						
bit 7	TMR1GIE: T	imer1 Gate Inte	errupt Enable I	oit				
	1 = Enables	the Timer1 gate	e acquisition ir	nterrupt				
	0 = Disables	the Timer1 gate	e acquisition i	nterrupt				
bit 6	ADIE: Analo	g-to-Digital Con	verter (ADC)	Interrupt Enabl	e bit			
	1 = Enables the ADC interrupt							
		the ADC interru	-	.,				
bit 5		RT Receive Inter		it				
	 1 = Enables the USART receive interrupt 0 = Disables the USART receive interrupt 							
bit 4		T Transmit Inte	-					
		the USART transmit interrupt						
		the USART tra						
bit 3	SSP1IE: Syr	nchronous Seria	I Port (MSSP) Interrupt Enat	ole bit			
		the MSSP inter	•					
		the MSSP inter	•					
bit 2	-	nted: Read as '						
bit 1		IR2 to PR2 Mat						
	1 = Enables the Timer2 to PR2 match interrupt							
bit 0	0 = Disables the Timer2 to PR2 match interrupt							
	TMR1IE: Timer1 Overflow Interrupt Enable bit 1 = Enables the Timer1 overflow interrupt							
		the Timer1 ove						
Note: Bit	PEIE of the IN	ITCON register	must he					
		peripheral inter						

REGISTER 7-2: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

10.4 User ID, Device ID and Configuration Word Access

Instead of accessing program memory, the User ID's, Device ID/Revision ID and Configuration Words can be accessed when CFGS = 1 in the PMCON1 register. This is the region that would be pointed to by PC<15> = 1, but not all addresses are accessible. Different access may exist for reads and writes. Refer to Table 10-2.

When read access is initiated on an address outside the parameters listed in Table 10-2, the PMDATH:PMDATL register pair is cleared, reading back '0's.

Address	Function	Read Access	Write Access
8000h-8003h	User IDs	Yes	Yes
8006h	Device ID/Revision ID	Yes	No
8007h-8008h	Configuration Words 1 and 2	Yes	No

EXAMPLE 10-4: CONFIGURATION WORD AND DEVICE ID ACCESS

* PROG_ADD	This code block will read 1 word of program memory at the memory address: PROG_ADDR_LO (must be 00h-08h) data will be returned in the variables; PROG_DATA_HI, PROG_DATA_LO							
BANKSEL	PMADRL	; Select correct Bank						
MOVLW	PROG_ADDR_LO	;						
MOVWF	PMADRL	; Store LSB of address						
CLRF	PMADRH	; Clear MSB of address						
BSF	PMCON1,CFGS	; Select Configuration Space						
BCF	INTCON,GIE	; Disable interrupts						
BSF	PMCON1,RD	; Initiate read						
NOP		; Executed (See Figure 10-2)						
NOP		; Ignored (See Figure 10-2)						
BSF	INTCON, GIE	; Restore interrupts						
MOVF	PMDATL,W	; Get LSB of word						
MOVWF		; Store in user location						
MOVF		; Get MSB of word						
MOVWF		; Store in user location						

11.8 Register Definitions: PORTC

REGISTER 11-12: PORTC: PORTC REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'							
u = Bit is unchanged x = Bit is unknown -n/n = Value at POR and BOR/Value at all othe			ther Resets				
'1' = Bit is set		'0' = Bit is clea	ared				

bit 7-0 **RC<7:0>**: PORTC General Purpose I/O Pin bits 1 = Port pin is ≥ VIH 0 = Port pin is ≤ VIL

REGISTER 11-13: TRISC: PORTC TRI-STATE REGISTER

| R/W-1/1 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| TRISC7 | TRISC6 | TRISC5 | TRISC4 | TRISC3 | TRISC2 | TRISC1 | TRISC0 |
| bit 7 | | | | | | | bit 0 |

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 TRISC<7:0>: PORTC Tri-State Control bits

1 = PORTC pin configured as an input (tri-stated)

0 = PORTC pin configured as an output

REGISTER 11-14: LATC: PORTC DATA LATCH REGISTER

| R/W-x/u |
|---------|---------|---------|---------|---------|---------|---------|---------|
| LATC7 | LATC6 | LATC5 | LATC4 | LATC3 | LATC2 | LATC1 | LATC0 |
| bit 7 | | | | | | | bit 0 |

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 LATC<7:0>: PORTC Output Latch Value bits⁽¹⁾

Note 1: Writes to PORTC are actually written to corresponding LATC register. Reads from PORTC register is return of actual I/O pin values.

19.1 Timer1 Operation

The Timer1 module is a 16-bit incrementing counter which is accessed through the TMR1H:TMR1L register pair. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter and increments on every selected edge of the external source.

Timer1 is enabled by configuring the TMR1ON and TMR1GE bits in the T1CON and T1GCON registers, respectively. Table 19-1 displays the Timer1 enable selections.

TABLE 19-1:	TIMER1 ENABLE
	SELECTIONS

TMR10N	TMR1GE	Timer1 Operation
0	0	Off
0	1	Off
1	0	Always On
1	1	Count Enabled

19.2 Clock Source Selection

The TMR1CS<1:0> and T1OSCEN bits of the T1CON register are used to select the clock source for Timer1. Table 19-2 displays the clock source selections.

19.2.1 INTERNAL CLOCK SOURCE

When the internal clock source is selected, the TMR1H:TMR1L register pair will increment on multiples of Fosc as determined by the Timer1 prescaler.

When the Fosc internal clock source is selected, the Timer1 register value will increment by four counts every instruction clock cycle. Due to this condition, a 2 LSB error in resolution will occur when reading the Timer1 value. To utilize the full resolution of Timer1, an asynchronous input signal must be used to gate the Timer1 clock input.

The following asynchronous sources may be used:

- Asynchronous event on the T1G pin to Timer1 gate
- · C1 or C2 comparator input to Timer1 gate

19.2.2 EXTERNAL CLOCK SOURCE

When the external clock source is selected, the Timer1 module may work as a timer or a counter.

When enabled to count, Timer1 is incremented on the rising edge of the external clock input T1CKI. The external clock source can be synchronized to the microcontroller system clock or it can run asynchronously.

Note: In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge after any one or more of the following conditions:

- Timer1 enabled after POR
- Write to TMR1H or TMR1L
- Timer1 is disabled
- Timer1 is disabled (TMR1ON = 0) when T1CKI is high then Timer1 is enabled (TMR1ON=1) when T1CKI is low.

TABLE 19-2: CLOCK SOURCE SELECTIONS	
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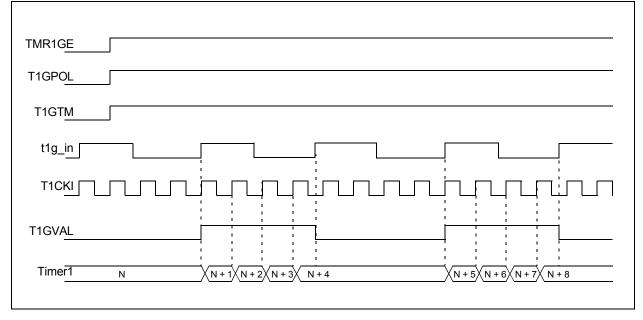
	TMR1CS<1:0>	T1OSCEN	Clock Source
	11	х	LFINTOSC
	10	1	Secondary Oscillator Circuit on SOSCI/SOSCO Pins
10 0 External Clocking on T1CKI Pin		External Clocking on T1CKI Pin	
	01	х	System Clock (Fosc)
	00	х	Instruction Clock (Fosc/4)

PIC16(L)F1508/9



TMR1GE				
T1GPOL				
t1g_in	7			
Т1СКІ				
T1GVAL				
Timer1 N		<u> N + 1</u>	N + 2	N + 3 N + 4

FIGURE 19-4: TIMER1 GATE TOGGLE MODE



20.1 Timer2 Operation

The clock input to the Timer2 module is the system instruction clock (Fosc/4).

TMR2 increments from 00h on each clock edge.

A 4-bit counter/prescaler on the clock input allows direct input, divide-by-4 and divide-by-16 prescale options. These options are selected by the prescaler control bits, T2CKPS<1:0> of the T2CON register. The value of TMR2 is compared to that of the Period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/ postscaler (see **Section 20.2 "Timer2 Interrupt"**).

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, whereas the PR2 register initializes to FFh. Both the prescaler and postscaler counters are cleared on the following events:

- a write to the TMR2 register
- · a write to the T2CON register
- Power-on Reset (POR)
- Brown-out Reset (BOR)
- MCLR Reset
- Watchdog Timer (WDT) Reset
- Stack Overflow Reset
- Stack Underflow Reset
- RESET Instruction

Note: TMR2 is not cleared when T2CON is written.

20.2 Timer2 Interrupt

Timer2 can also generate an optional device interrupt. The Timer2 output signal (T2_match) provides the input for the 4-bit counter/postscaler. This counter generates the TMR2 match interrupt flag which is latched in TMR2IF of the PIR1 register. The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE of the PIE1 register.

A range of 16 postscale options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS<3:0>, of the T2CON register.

20.3 Timer2 Output

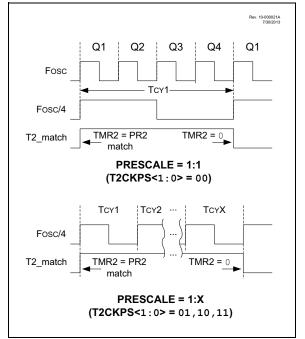
The output of TMR2 is T2_match. T2_match is available to the following peripherals:

- Configurable Logic Cell (CLC)
- Master Synchronous Serial Port (MSSP)
- Numerically Controlled Oscillator (NCO)
- Pulse Width Modulator (PWM)

The T2_match signal is synchronous with the system clock. Figure 20-3 shows two examples of the timing of the T2_match signal relative to Fosc and prescale value, T2CKPS<1:0>. The upper diagram illustrates 1:1 prescale timing and the lower diagram, 1:X prescale timing.

FIGURE 20-3: T2

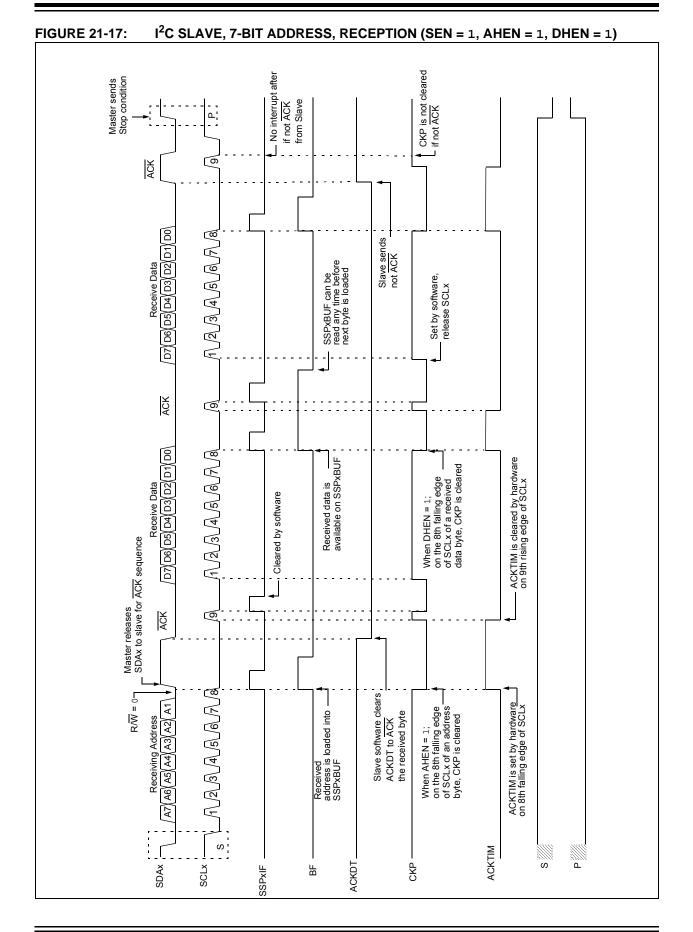
T2_MATCH TIMING DIAGRAM



20.4 Timer2 Operation During Sleep

Timer2 cannot be operated while the processor is in Sleep mode. The contents of the TMR2 and PR2 registers will remain unchanged while the processor is in Sleep mode.

PIC16(L)F1508/9



Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	_	SCKP	BRG16		WUE	ABDEN	235
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	75
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	_	TMR2IE	TMR1IE	76
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	_	TMR2IF	TMR1IF	79
RCREG			EUS	ART Receiv	ve Data Reg	jister			228*
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	234*
SPBRGL				BRG	<7:0>				236*
SPBRGH	BRG<15:8>								236*
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	113
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	233

TABLE 22-2: SUMMARY OF REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for asynchronous reception.

* Page provides register information.

24.1.5 CLCx SETUP STEPS

The following steps should be followed when setting up the CLCx:

- Disable CLCx by clearing the LCxEN bit.
- Select desired inputs using CLCxSEL0 and CLCxSEL1 registers (See Table 24-1).
- Clear any associated ANSEL bits.
- · Set all TRIS bits associated with inputs.
- · Clear all TRIS bits associated with outputs.
- Enable the chosen inputs through the four gates using CLCxGLS0, CLCxGLS1, CLCxGLS2, and CLCxGLS3 registers.
- Select the gate output polarities with the LCxPOLy bits of the CLCxPOL register.
- Select the desired logic function with the LCxMODE<2:0> bits of the CLCxCON register.
- Select the desired polarity of the logic output with the LCxPOL bit of the CLCxPOL register. (This step may be combined with the previous gate output polarity step).
- If driving a device, set the LCxOE bit in the CLCxCON register and also clear the TRIS bit corresponding to that output.
- If interrupts are desired, configure the following bits:
 - Set the LCxINTP bit in the CLCxCON register for rising event.
 - Set the LCxINTN bit in the CLCxCON register or falling event.
 - Set the CLCxIE bit of the associated PIE registers.
 - Set the GIE and PEIE bits of the INTCON register.
- Enable the CLCx by setting the LCxEN bit of the CLCxCON register.

24.2 CLCx Interrupts

An interrupt will be generated upon a change in the output value of the CLCx when the appropriate interrupt enables are set. A rising edge detector and a falling edge detector are present in each CLC for this purpose.

The CLCxIF bit of the associated PIR registers will be set when either edge detector is triggered and its associated enable bit is set. The LCxINTP enables rising edge interrupts and the LCxINTN bit enables falling edge interrupts. Both are located in the CLCxCON register.

To fully enable the interrupt, set the following bits:

- · LCxON bit of the CLCxCON register
- · CLCxIE bit of the associated PIE registers
- LCxINTP bit of the CLCxCON register (for a rising edge detection)
- LCxINTN bit of the CLCxCON register (for a falling edge detection)
- · PEIE and GIE bits of the INTCON register

The CLCxIF bit of the associated PIR registers, must be cleared in software as part of the interrupt service. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

24.3 Output Mirror Copies

Mirror copies of all LCxCON output bits are contained in the CLCxDATA register. Reading this register reads the outputs of all CLCs simultaneously. This prevents any reading skew introduced by testing or reading the CLCxOUT bits in the individual CLCxCON registers.

24.4 Effects of a Reset

The CLCxCON register is cleared to zero as the result of a Reset. All other selection and gating values remain unchanged.

24.5 Operation During Sleep

The CLC module operates independently from the system clock and will continue to run during Sleep, provided that the input sources selected remain active.

The HFINTOSC remains active during Sleep when the CLC module is enabled and the HFINTOSC is selected as an input source, regardless of the system clock source selected.

In other words, if the HFINTOSC is simultaneously selected as the system clock and as a CLC input source, when the CLC is enabled, the CPU will go idle during Sleep, but the CLC will continue to operate and the HFINTOSC will remain active.

This will have a direct effect on the Sleep mode current.

25.2 Fixed Duty Cycle (FDC) Mode

In Fixed Duty Cycle (FDC) mode, every time the accumulator overflows (NCO_overflow), the output is toggled. This provides a 50% duty cycle, provided that the increment value remains constant. For more information, see Figure 25-2.

The FDC mode is selected by clearing the NxPFM bit in the NCOxCON register.

25.3 Pulse Frequency (PF) Mode

In Pulse Frequency (PF) mode, every time the accumulator overflows (NCO_overflow), the output becomes active for one or more clock periods. Once the clock period expires, the output returns to an inactive state. This provides a pulsed output.

The output becomes active on the rising clock edge immediately following the overflow event. For more information, see Figure 25-2.

The value of the active and inactive states depends on the polarity bit, NxPOL in the NCOxCON register.

The PF mode is selected by setting the NxPFM bit in the NCOxCON register.

25.3.1 OUTPUT PULSE WIDTH CONTROL

When operating in PF mode, the active state of the output can vary in width by multiple clock periods. Various pulse widths are selected with the NxPWS<2:0> bits in the NCOxCLK register.

When the selected pulse width is greater than the accumulator overflow time frame, the output of the NCOx operation is indeterminate.

25.4 Output Polarity Control

The last stage in the NCOx module is the output polarity. The NxPOL bit in the NCOxCON register selects the output polarity. Changing the polarity while the interrupts are enabled will cause an interrupt for the resulting output transition.

The NCOx output can be used internally by source code or other peripherals. Accomplish this by reading the NxOUT (read-only) bit of the NCOxCON register.

The NCOx output signal is available to the following peripherals:

- CLC
- CWG

25.5 Interrupts

When the accumulator overflows (NCO_overflow), the NCOx Interrupt Flag bit, NCOxIF, of the PIRx register is set. To enable the interrupt event (NCO_interrupt), the following bits must be set:

- NxEN bit of the NCOxCON register
- · NCOxIE bit of the PIEx register
- · PEIE bit of the INTCON register
- GIE bit of the INTCON register

The interrupt must be cleared by software by clearing the NCOxIF bit in the Interrupt Service Routine.

25.6 Effects of a Reset

All of the NCOx registers are cleared to zero as the result of a Reset.

25.7 Operation In Sleep

The NCO module operates independently from the system clock and will continue to run during Sleep, provided that the clock source selected remains active.

The HFINTOSC remains active during Sleep when the NCO module is enabled and the HFINTOSC is selected as the clock source, regardless of the system clock source selected.

In other words, if the HFINTOSC is simultaneously selected as the system clock and the NCO clock source, when the NCO is enabled, the CPU will go idle during Sleep, but the NCO will continue to operate and the HFINTOSC will remain active.

This will have a direct effect on the Sleep mode current.

25.8 Alternate Pin Locations

This module incorporates I/O pins that can be moved to other locations with the use of the alternate pin function register, APFCON. To determine which pins can be moved and what their default locations are upon a Reset, see **Section 11.1 "Alternate Pin Function**" for more information.

REGISTER 25-3: NCOxACCL: NCOx ACCUMULATOR REGISTER – LOW BYTE

| R/W-0/0 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| | | | NCOxA | CC<7:0> | | | |
| bit 7 | | | | | | | bit 0 |
| | | | | | | | |
| Legend: | | | | | | | |
| | 1.11 | | | | | | |

'1' = Bit is set	'0' = Bit is cleared	
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'

Accumulator, Low Byte
ŀ

REGISTER 25-4: NCOxACCH: NCOx ACCUMULATOR REGISTER – HIGH BYTE

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0		
			NCOxAC	C<15:8>					
bit 7							bit 0		
Legend:									
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'					

bit 7-0 NCOxACC<15:8>: NCOx Accumulator, High Byte

'0' = Bit is cleared

REGISTER 25-5: NCOxACCU: NCOx ACCUMULATOR REGISTER – UPPER BYTE

U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—		NCOXAC	C<19:16>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-4 Unimplemented: Read as '0'

bit 3-0 NCOxACC<19:16>: NCOx Accumulator, Upper Byte

'1' = Bit is set

27.0 IN-CIRCUIT SERIAL PROGRAMMING[™] (ICSP[™])

ICSP[™] programming allows customers to manufacture circuit boards with unprogrammed devices. Programming can be done after the assembly process allowing the device to be programmed with the most recent firmware or a custom firmware. Five pins are needed for ICSP[™] programming:

- ICSPCLK
- ICSPDAT
- MCLR/VPP
- VDD
- Vss

In Program/Verify mode the program memory, user IDs and the Configuration Words are programmed through serial communications. The ICSPDAT pin is a bidirectional I/O used for transferring the serial data and the ICSPCLK pin is the clock input. For more information on ICSPTM refer to the "*PIC12(L)F1501/PIC16(L)F150X Memory Programming Specification*" (DS41573).

27.1 High-Voltage Programming Entry Mode

The device is placed into High-Voltage Programming Entry mode by holding the ICSPCLK and ICSPDAT pins low then raising the voltage on MCLR/VPP to VIHH.

27.2 Low-Voltage Programming Entry Mode

The Low-Voltage Programming Entry mode allows the PIC[®] Flash MCUs to be programmed using VDD only, without high voltage. When the LVP bit of Configuration Words is set to '1', the ICSP Low-Voltage Programming Entry mode is enabled. To disable the Low-Voltage ICSP mode, the LVP bit must be programmed to '0'.

Entry into the Low-Voltage Programming Entry mode requires the following steps:

- 1. MCLR is brought to VIL.
- 2. A 32-bit key sequence is presented on ICSPDAT, while clocking ICSPCLK.

Once the key sequence is complete, $\overline{\text{MCLR}}$ must be held at VIL for as long as Program/Verify mode is to be maintained.

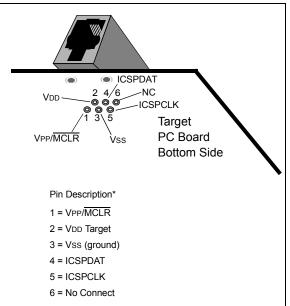
If low-voltage programming is enabled (LVP = 1), the $\overline{\text{MCLR}}$ Reset function is automatically enabled and cannot be disabled. See **Section 6.5** "**MCLR**" for more information.

The LVP bit can only be reprogrammed to '0' by using the High-Voltage Programming mode.

27.3 Common Programming Interfaces

Connection to a target device is typically done through an ICSP[™] header. A commonly found connector on development tools is the RJ-11 in the 6P6C (6-pin, 6-connector) configuration. See Figure 27-1.





Another connector often found in use with the PICkit[™] programmers is a standard 6-pin header with 0.1 inch spacing. Refer to Figure 27-2.

29.0 ELECTRICAL SPECIFICATIONS

29.1 Absolute Maximum Ratings^(†)

Ambient temperature under bias	-40°C to +125°C
Storage temperature	
Voltage on pins with respect to Vss	
on VDD pin	
PIC16F1508/9	-0.3V to +6.5V
PIC16LF1508/9	
on MCLR pin	
on all other pins	
Maximum current	
on Vss pin ⁽¹⁾	
-40°C \leq TA \leq +85°C	250 mA
+85°C \leq TA \leq +125°C	
on VDD pin ⁽¹⁾	
-40°C \leq TA \leq +85°C	250 mA
+85°C \leq TA \leq +125°C	85 mA
Sunk by any standard I/O pin	50 mA
Sourced by any standard I/O pin	50 mA
Clamp current, Ik (VPIN < 0 or VPIN > VDD)	±20 mA
Total power dissipation ⁽²⁾	

Note 1: Maximum current rating requires even load distribution across I/O pins. Maximum current rating may be limited by the device package power dissipation characterizations, see Table 29-6 to calculate device specifications.

2: Power dissipation is calculated as follows: PDIS = VDD x {IDD $-\Sigma$ IOH} + Σ {(VDD - VOH) x IOH} + Σ (VOI x IOL).

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability.

29.3 DC Characteristics

TABLE 29-1: SUPPLY VOLTAGE

PIC16LF	1508/9		Standard	d Opera	ating Con	ditions (unless otherwise stated)		
PIC16F1	508/9								
Param. Sym. No.		Sym. Characteristic	Min.	Тур†	Max.	Units	Conditions		
D001	Vdd	Supply Voltage							
			VDDMIN 1.8 2.5	_	VDDMAX 3.6 3.6	V V	Fosc ≤ 16 MHz Fosc ≤ 20 MHz		
D001			2.3 2.5	_	5.5 5.5	V V	Fosc ≤ 16 MHz Fosc ≤ 20 MHz		
D002*	Vdr	RAM Data Retention Voltage ⁽¹⁾							
			1.5		_	V	Device in Sleep mode		
D002*			1.7		—	V	Device in Sleep mode		
D002A*	VPOR	Power-on Reset Release Voltage	(2)						
			_	1.6	—	V			
D002A*			—	1.6	—	V			
D002B*	VPORR*	Power-on Reset Rearm Voltage ⁽²⁾)						
			—	0.8	_	V			
D002B*			_	1.5	_	V			
D003	VFVR	Fixed Voltage Reference Voltage							
		1x gain (1.024V nominal) 2x gain (2.048V nominal) 4x gain (4.096V nominal)	-4 -3	_	+4 +7	% %	$ \begin{array}{l} V{\rm DD} \geq 2.5V, \ -40^{\circ}{\rm C} \leq {\rm TA} \leq +85^{\circ}{\rm C} \\ V{\rm DD} \geq 2.5V, \ -40^{\circ}{\rm C} \leq {\rm TA} \leq +85^{\circ}{\rm C} \\ V{\rm DD} \geq 4.75V, \ -40^{\circ}{\rm C} \leq {\rm TA} \leq +85^{\circ}{\rm C} \end{array} $		
D004*	SVDD	VDD Rise Rate ⁽²⁾	0.05	—	—	V/ms	Ensures that the Power-on Reset signal is released properly.		

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in Sleep mode without losing RAM data.

2: See Figure 29-3, POR and POR REARM with Slow Rising VDD.

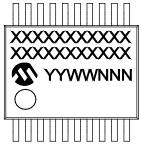
Example

PIC16F1508

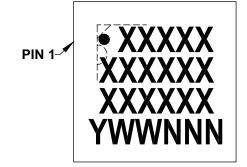
-E/SS @3

Package Marking Information (Continued)

20-Lead SSOP (5.30 mm)

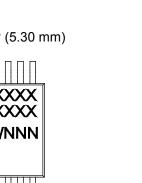


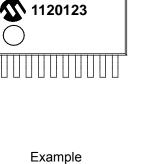
20-Lead QFN (4x4x0.9 mm) 20-Lead UQFN (4x4x0.5 mm)





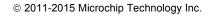
PIN 1-





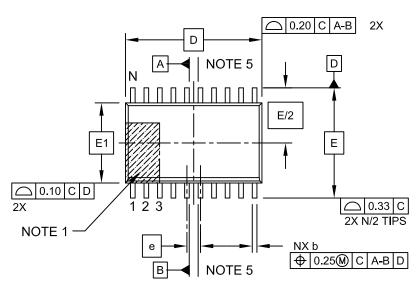
• PIC16 F1508 E/ML @3

120123

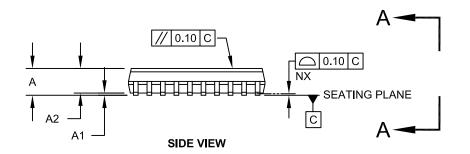


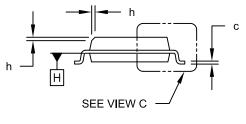
20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging







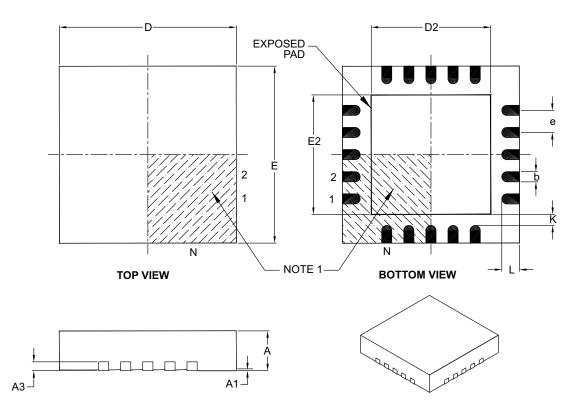


VIEW A-A

Microchip Technology Drawing C04-094C Sheet 1 of 2

20-Lead Plastic Quad Flat, No Lead Package (ML) – 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimensio	Dimension Limits		NOM	MAX
Number of Pins	Ν	20		
Pitch	е	0.50 BSC		
Overall Height	А	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.20 REF		
Overall Width	E	4.00 BSC		
Exposed Pad Width	E2	2.60	2.70	2.80
Overall Length	D	4.00 BSC		
Exposed Pad Length	D2	2.60	2.70	2.80
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	К	0.20	_	_

Notes:

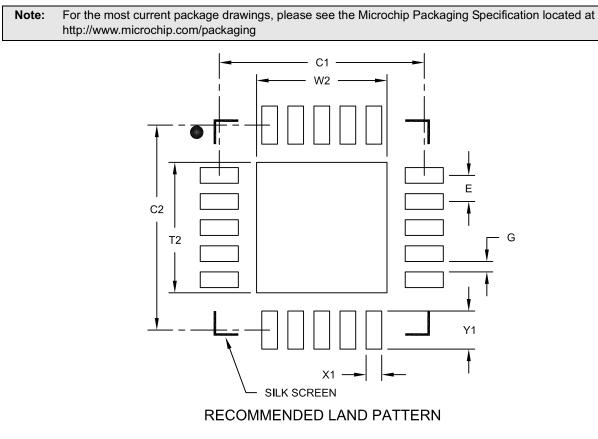
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-126B

20-Lead Plastic Quad Flat, No Lead Package (ML) - 4x4 mm Body [QFN] With 0.40 mm Contact Length



Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Contact Pitch	E		0.50 BSC		
Optional Center Pad Width	W2			2.50	
Optional Center Pad Length	T2			2.50	
Contact Pad Spacing	C1		3.93		
Contact Pad Spacing	C2		3.93		
Contact Pad Width	X1			0.30	
Contact Pad Length	Y1			0.73	
Distance Between Pads	G	0.20			

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2126A

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